

Features

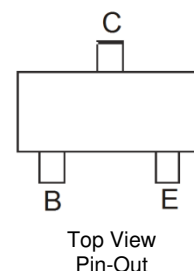
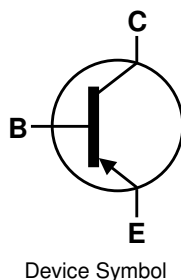
- $BV_{CEO} > -40V$
- $BV_{ECO} > -3V$
- $I_C = -3A$ Continuous Collector Current
- $V_{CE(sat)} < -85mV @ -1A$
- $R_{CE(sat)} = 55m\Omega$ typical
- $P_D = 1.25W$
- High Power Dissipation SOT23 Package
- High Peak Current
- Low Saturation Voltage
- 3V Reverse Blocking Voltage
- Complementary Part Number: ZXTN25040DFH
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at**
<https://www.diodes.com/products/automotive/automotive-products/>.
- **This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.**
<https://www.diodes.com/quality/product-definitions/>

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (Ⓔ)
- Weight: 0.008 grams (Approximate)

Applications

- MOSFET and IGBT gate driving
- DC-DC converters
- Motor drives
- High-side drivers

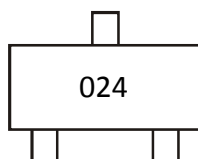


Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTP25040DFHTA	024	7	8	3,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



024 = Product Type Marking Code

Absolute Maximum Ratings @ T_A = +25°C, unless otherwise specified.

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CB0}	-45	V
Collector-Emitter Voltage (Forward Blocking)	V _{CEO}	-40	V
Emitter-collector voltage (Reverse Blocking)	V _{ECO}	-3	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	I _C	-3	A
Peak Pulse Current	I _{CM}	-9	A

Thermal Characteristics @ T_A = +25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation Linear derating factor	P _D	0.73	W mW/°C
		5.84	
		0.78	
		6.24	
		1.05	
		8.4	
Thermal Resistance, Junction to Ambient	R _{θJA}	1.25	°C/W
		9.6	
		1.81	
		14.5	
		171	
Thermal Resistance, Junction to Ambient	R _{θJA}	160	°C/W
		119	
		100	
		69	
Thermal Resistance, Junction to Lead	R _{θJL}	74.95	°C/W
Thermal Resistance, Junction to Case	R _{θJC}	45	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

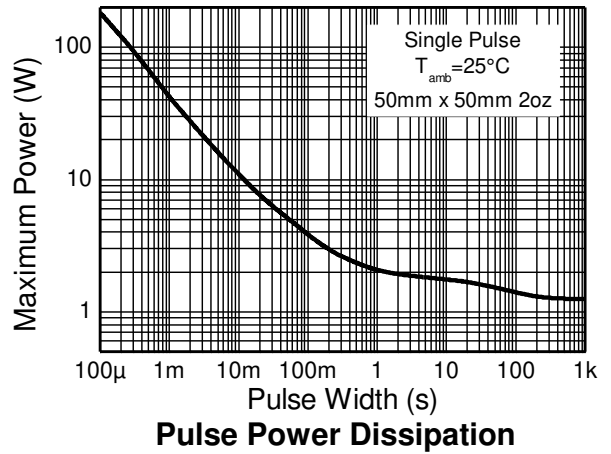
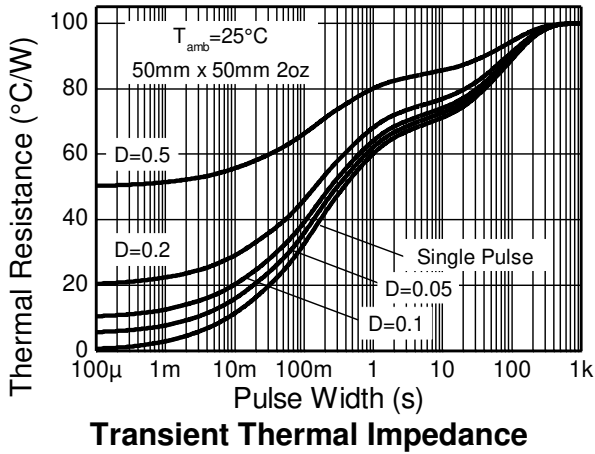
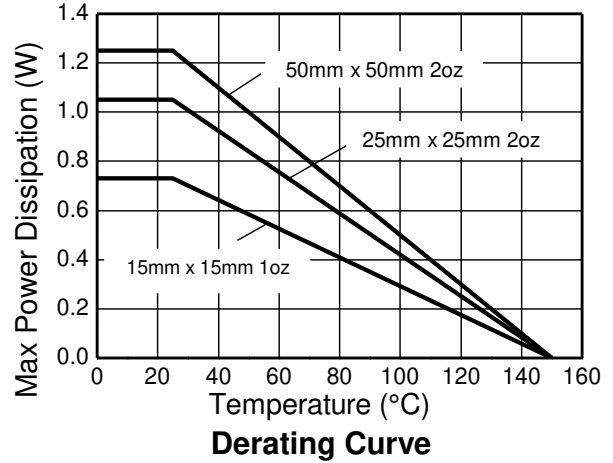
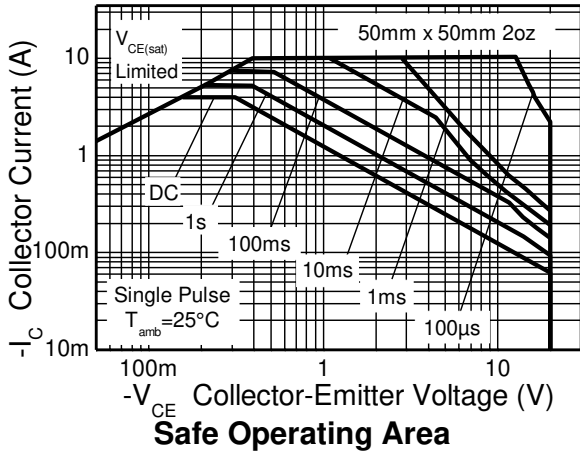
- Notes:
5. For a device surface mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 6. Same as note (5), except the device is mounted on FR4 substrate PCB layout with minimum recommended pad layout.
 7. Same as note (5), except the device is surface mounted on 25mm x 25mm with 2 oz copper.
 8. Same as note (5), except the device is surface mounted on 50mm x 50mm with 2 oz copper.
 9. Same as note (8), except the device is measured at t<5secs.
 10. Thermal resistance from junction to solder-point (at the end of the collector lead).
 11. Thermal resistance from junction to the top of the case.

ESD Ratings (Note 12)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

Note: 12. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

Thermal Characteristics and Derating Information

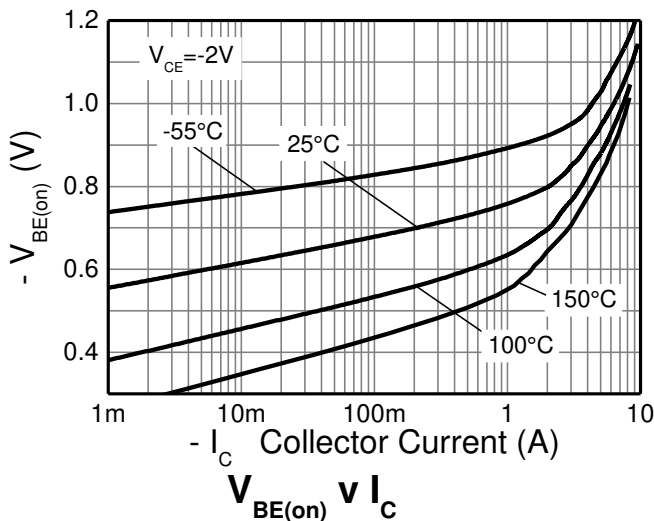
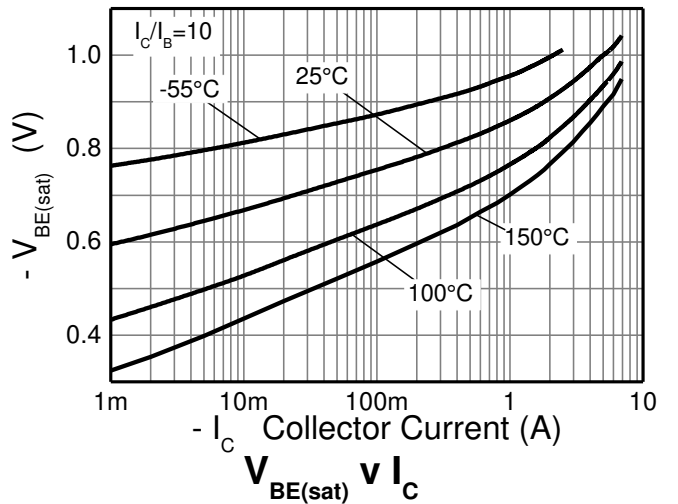
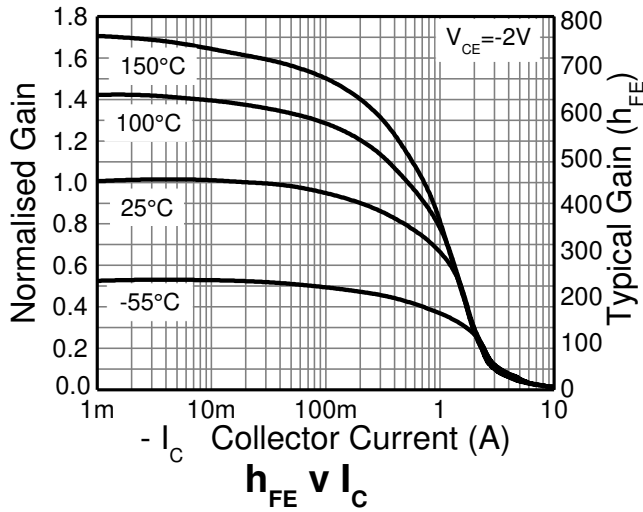
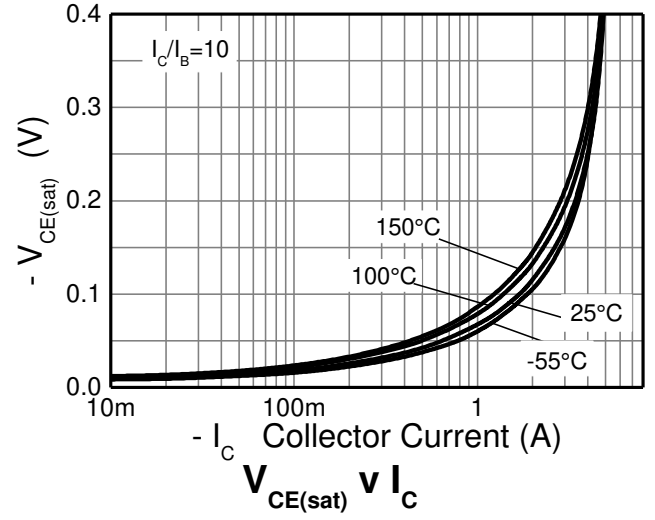
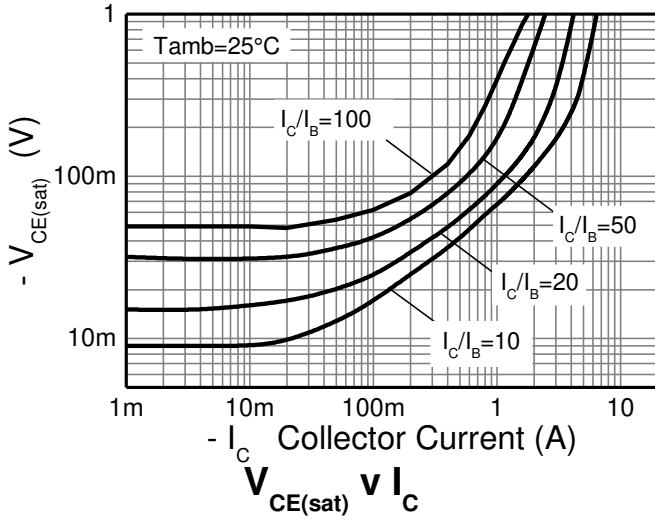


Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_{CBO}	-45	-75	-	V	$I_C = -100\mu\text{A}$
Collector-Emitter Breakdown Voltage (Note 13)	BV_{CEO}	-40	-65	-	V	$I_C = -10\text{mA}$
Emitter-Base Breakdown Voltage	BV_{EBO}	-7	-8.2	-	V	$I_E = -100\mu\text{A}$
Emitter-Collector Breakdown Voltage	BV_{ECO}	-3	-8.7	-	V	$I_E = -100\mu\text{A}$
Collector-Base Cutoff Current	I_{CBO}	-	< -1	-50	nA	$V_{CB} = -45\text{V}$
		-	-	-0.5	μA	$V_{CB} = -45\text{V}, T_{amb} = +100^\circ\text{C}$
Emitter-Base Cutoff Current	I_{EBO}	-	< -1	-50	nA	$V_{EB} = -5.6\text{V}$
Static Forward Current Transfer Ratio (Note 13)	h_{FE}	300	450	900	-	$I_C = -10\text{mA}, V_{CE} = -2\text{V}$
		200	300	-		$I_C = -1\text{A}, V_{CE} = -2\text{V}$
		30	60	-		$I_C = -3\text{A}, V_{CE} = -2\text{V}$
Collector-Emitter Saturation Voltage (Note 13)	$V_{CE(sat)}$	-	-170	-260	mV	$I_C = -1\text{A}, I_B = -20\text{mA}$
		-	-65	-85		$I_C = -1\text{A}, I_B = -100\text{mA}$
		-	-165	-220		$I_C = -3\text{A}, I_B = -300\text{mA}$
Base-Emitter Saturation Voltage (Note 13)	$V_{BE(sat)}$	-	-930	-1000	mV	$I_C = -3\text{A}, I_B = -300\text{mA}$
Base-Emitter Saturation Voltage (Note 13)	$V_{BE(on)}$	-	-830	-900	mV	$I_C = -3\text{A}, V_{CE} = -2\text{V}$
Output Capacitance	C_{obo}	-	17.4		pF	$V_{CB} = -10\text{V}, f = 1\text{MHz}$
Transition Frequency	f_T	-	270	-	MHz	$V_{CE} = -10\text{V}, I_C = -50\text{mA}, f = 100\text{MHz}$
Turn-on Time	$t_{(on)}$	-	75.5	-	ns	$V_{CC} = -15\text{V}, I_C = -750\text{mA}, I_{B1} = -I_{B2} = -15\text{mA}$
Turn-off Time	$t_{(off)}$	-	320	-	ns	

Note: 13. Measured under pulsed conditions. Pulse width $\leq 300 \mu\text{s}$. Duty cycle $\leq 2\%$.

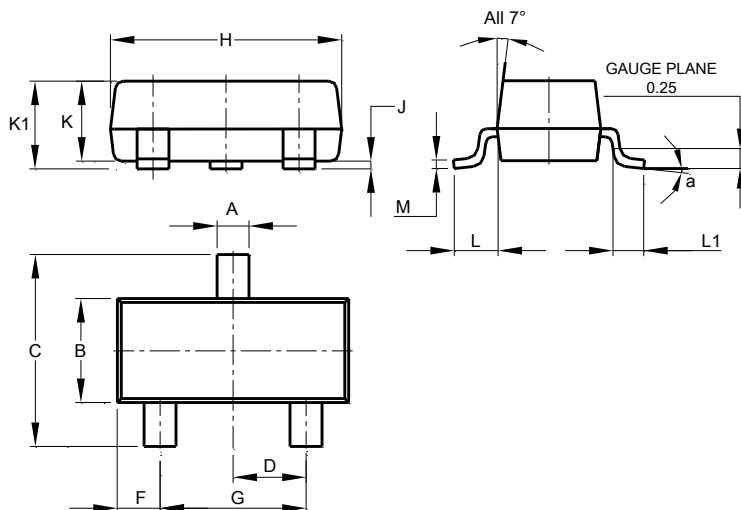
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23

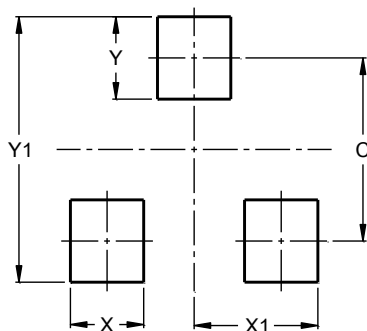


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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